

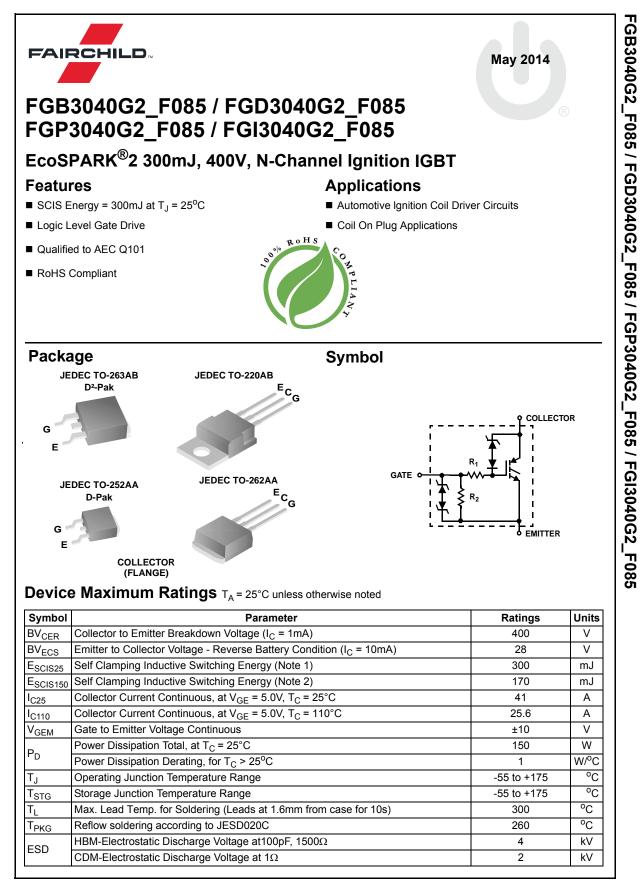
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Devic	e Marking	Device	Package	Reel Size Ta		ape Width		Quantity	
FGE	33040G2	FGB3040G2_F085	TO-263AB	330n	nm	24mm		80	0
FGI	GD3040G2 FGD3040G2_F085		TO-252AA	330n	าฑ	16mm		250	0
FGF	P3040G2	FGP3040G2_F085	TO-220AB	Tub	е	N/A		50	
FGI	3040G2	FGI3040G2_F085	TO-262AA	TO-262AA Tube		N/A		50	
lectr	ical Char	racteristics T _A = 25°	°C unless otherwise no	oted					
Symbol		Parameter	Test Co	onditio	ns	Min	Тур	Max	Units
V _{CER}	Collector to E	mitter Breakdown Voltage	$T_{\rm J} = -40$ to 150°C			370	400	430	v
8V _{CES}	Collector to E	mitter Breakdown Voltage	$I_{CE} = 10$ mA, $V_{GE} = 0$ R _{GE} = 0, T _J = -40 to 150 ^o C	V,		390	420	450	v
BV _{ECS}	Emitter to Co	llector Breakdown Voltage	I _{CE} = -20mA, V _{GE} = 0 T _J = 25°C	IV,		28	-	-	V
3V _{GES}	Gate to Emitt	er Breakdown Voltage	I_{GES} = ±2mA			±12	±14	-	V
CER	Collector to F	Emitter Leakage Current	V _{CE} = 250V, R _{GE} = 1		T _J = 25°C	-	-	25	μA
ER					T _J = 150 ^o C	-	-	1	mA
ECS	Emitter to Co	llector Leakage Current	V _{EC} = 24V,	-	T _J = 25 ^o C	-	-	1	mA
505		C			Т _Ј = 150 ^о С	-	-	40	110 (
1	Series Gate I					-	120	-	Ω
2	Gate to Emitt	er Resistance				10K	-	30K	Ω
n Sta	te Charact	eristics							
CE(SAT)	Collector to E	Emitter Saturation Voltage	$I_{CE} = 6A, V_{GE} = 4V,$		T _J = 25°C	-	1.15	1.25	V
CE(SAT)		Emitter Saturation Voltage	I _{CE} = 10A, V _{GE} = 4.5 ^v		T _J = 150 ^o C	-	1.35	1.50	V
CE(SAT)	Collector to E	Emitter Saturation Voltage	$I_{CE} = 15A, V_{GE} = 4.5V,$		T _J = 150 ^o C	-	1.68	1.85	V
SCIS	Self Clamped	Inductive Switching	L = 3.0 mHy,RG = 1K VGE = 5V, (Note 1)	Ω,	TJ = 25°C	-	-	300	mJ

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance Junction to Case	

Notes:

1: Self Clamping Inductive Switching Energy (E_{SCIS25}) of 300 mJ is based on the test conditions that starting Tj=25°C; L=3mHy, I_{SCIS}=14.2A,V_{CC}=100V during inductor charging and V_{CC}=0V during the time in clamp.

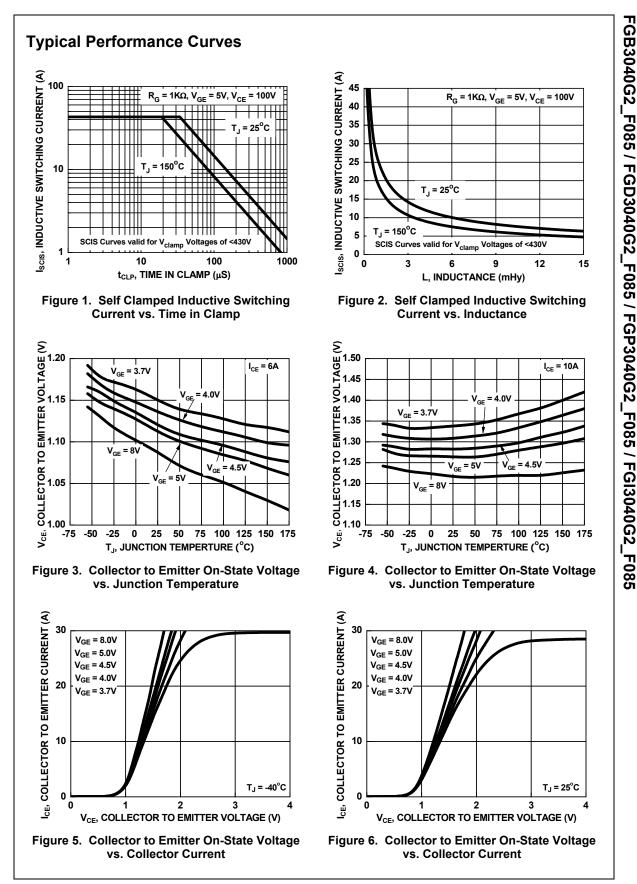
2: Self Clamping Inductive Switching Energy ($E_{SCIS150}$) of 170 mJ is based on the test conditions that starting Tj=150°C; L=3mHy, I_{SCIS}=10.8A,V_{CC}=100V during inductor charging and V_{CC}=0V during the time in clamp.

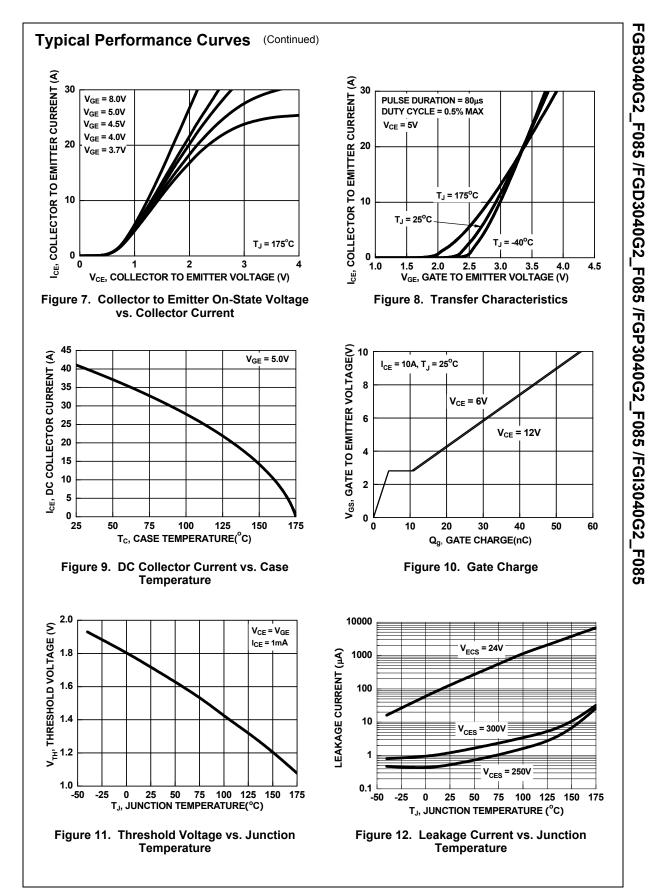
mJ °C/W

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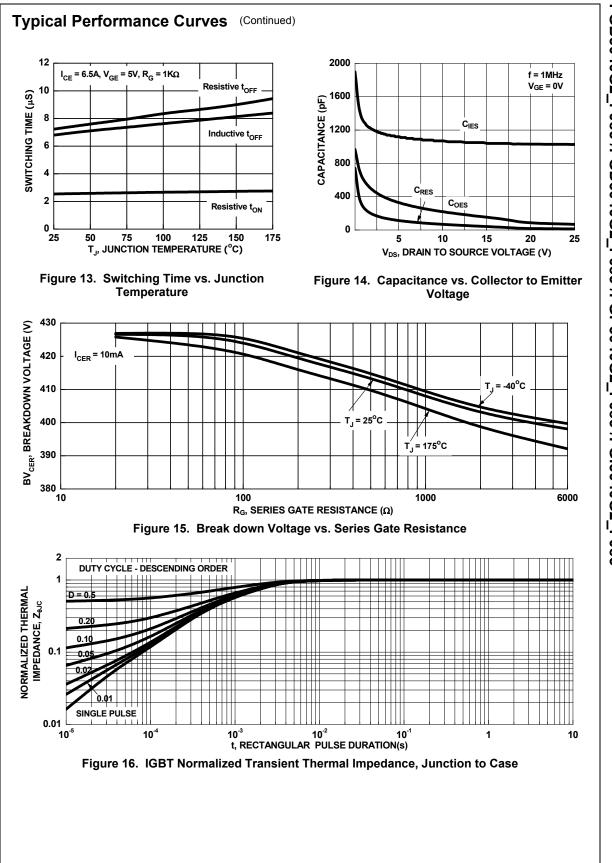
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V_{GEP}Gate to Emitter Plateau Voltage $V_{CE} = 12V$, $I_{CE} = 10A$ 0.73 1.2 1.0 Switching Characteristics $t_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V$, $R_L = 1\Omega$ $ 0.9$ 4 μs t_{rR} Current Rise Time-Resistive $V_{CE} = 5V$, $R_G = 1K\Omega$ $ 1.9$ 7 μs $t_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V$, $L = 1mH$, $ 4.8$ 15 μs $V_{GE} = 5V$, $R_G = 1K\Omega$ $V_{GE} = 5V$, $R_G = 1K\Omega$ $ 4.8$ 15 μs	V_{GEP}Gate to Emitter Plateau Voltage $V_{CE} = 12V$, $I_{CE} = 10A$ 0.73 1.2 1.0 Switching Characteristics $t_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V$, $R_L = 1\Omega$ $ 0.9$ 4 μs t_{rR} Current Rise Time-Resistive $V_{CE} = 5V$, $R_G = 1K\Omega$ $ 1.9$ 7 μs $t_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V$, $L = 1mH$, $ 4.8$ 15 μs $V_{GE} = 5V$, $R_G = 1K\Omega$ $V_{GE} = 5V$, $R_G = 1K\Omega$ $ 4.8$ 15 μs	V_{GEP}Gate to Emitter Plateau Voltage $V_{CE} = 12V$, $I_{CE} = 10A$ $ 2.8$ $ V$ Switching CharacteristicsSwitching Characteristics $I_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V$, $R_L = 1\Omega$ $ 0.9$ 4 μs V_{GE} $V_{CE} = 5V$, $R_G = 1K\Omega$ $ 1.2$ 1.0 $ 0.9$ 4 μs I_{rR} Current Rise Time-Resistive $V_{CE} = 300V$, $L = 1mH$, $ 1.9$ 7 μs $I_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V$, $L = 1mH$, $ 4.8$ 15 μs $V_{GE} = 5V$, $R_G = 1K\Omega$ 0.02 45 $ 0.2$ 45 $-$	V_{GEP}Gate to Emitter Plateau Voltage $V_{CE} = 12V$, $I_{CE} = 10A$ 0.73 1.2 1.0 Switching Characteristics $t_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V$, $R_L = 1\Omega$ $ 0.9$ 4 μs t_{rR} Current Rise Time-Resistive $V_{CE} = 5V$, $R_G = 1K\Omega$ $ 1.9$ 7 μs $t_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V$, $L = 1mH$, $ 4.8$ 15 μs $V_{GE} = 5V$, $R_G = 1K\Omega$ $V_{GE} = 5V$, $R_G = 1K\Omega$ $ 4.8$ 15 μs	V _{GE(TH)}	Gate to Emitter Threshold Voltage						v
Switching Characteristics $i_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ -0.94 μs i_{rR} Current Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ -1.97 μs $i_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ -4.815 μs $V_{GE} = 5V, R_G = 1K\Omega$ $V_{GE} = 5V, R_G = 1K\Omega$ -0.04.5 μs	Switching Characteristics $i_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ -0.94 μs i_{rR} Current Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ -1.97 μs $i_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ -4.815 μs $V_{GE} = 5V, R_G = 1K\Omega$ $V_{GE} = 5V, R_G = 1K\Omega$ -0.04.5 μs	Switching Characteristics $i_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ -0.94 μs i_{rR} Current Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ -1.97 μs $i_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ -4.815 μs $V_{GE} = 5V, R_G = 1K\Omega$ $V_{GE} = 5V, R_G = 1K\Omega$ -0.04.5 μs	Switching Characteristics $i_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 1\Omega$ -0.94 μs i_{rR} Current Rise Time-Resistive $V_{GE} = 5V, R_G = 1K\Omega$ -1.97 μs $i_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ -4.815 μs $V_{GE} = 5V, R_G = 1K\Omega$ $V_{GE} = 5V, R_G = 1K\Omega$ -0.04.5 μs		Gate to Emitter Plateau Voltage	V _{CE} = 12V, I _{CE} = 10A	1) = 150 C	_			V
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$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		•	V _{CE} = 14V, R _L = 1Ω		-	0.9	4	μS
$\frac{1}{d(OFF)L} Current Turn-Off Delay Time-Inductive V_{CE} = 300V, L = 1mH, V_{GE} = 5V, R_G = 1K\Omega$	$\frac{1}{d(OFF)L} Current Turn-Off Delay Time-Inductive V_{CE} = 300V, L = 1mH, V_{GE} = 5V, R_G = 1K\Omega$	$\frac{1}{d(OFF)L} Current Turn-Off Delay Time-Inductive V_{CE} = 300V, L = 1mH, V_{GE} = 5V, R_G = 1K\Omega$	$\frac{1}{d(OFF)L} Current Turn-Off Delay Time-Inductive V_{CE} = 300V, L = 1mH, V_{GE} = 5V, R_G = 1K\Omega$	rR	Current Rise Time-Resistive	V _{GE} = 5V, R _G = 1KΩ T _J = 25°C,		-	1.9	7	μS
t_{H_L} Current Fall Time-Inductive $V_{GE} = 5V, R_G = 1K\Omega$ $I_{CE} = 6.5A, T_J = 25^{\circ}C,$ - 2.0 15 µs	r_{H_L} Current Fall Time-Inductive $V_{GE} = 5V, R_G = 1K\Omega$ $I_{CE} = 6.5A, T_J = 25^{\circ}C,$ - 2.0 15 μ s	$r_{\rm AL}$ Current Fall Time-Inductive $V_{\rm QE} = 5V, R_{\rm G} = 1K\Omega$ $I_{\rm CE} = 6.5A, T_{\rm J} = 25^{\circ}C,$ - 2.0 15 μ s	$r_{\rm rt}$ Current Fall Time-Inductive $V_{\rm GE}^{a} = 5.5$, $T_{\rm J} = 25^{\circ}$ C, -2.0 15 μ s	d(OFF)L	Current Turn-Off Delay Time-Inductive	V _{CE} = 300V, L = 1mH,		-	4.8	15	μS
				fL	Current Fall Time-Inductive	$V_{GE} = 5V, R_G = 1K\Omega$		-	2.0	15	μS

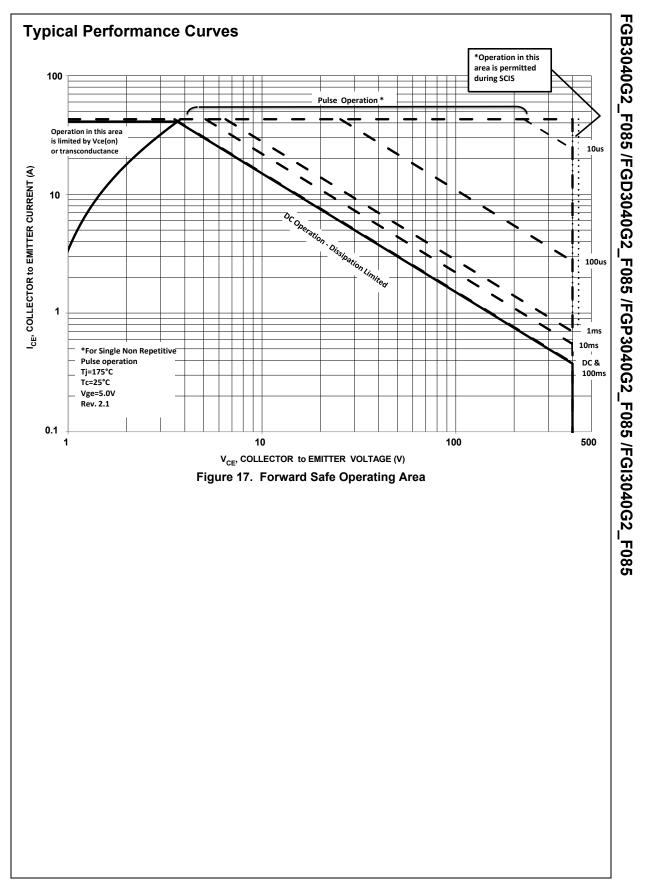


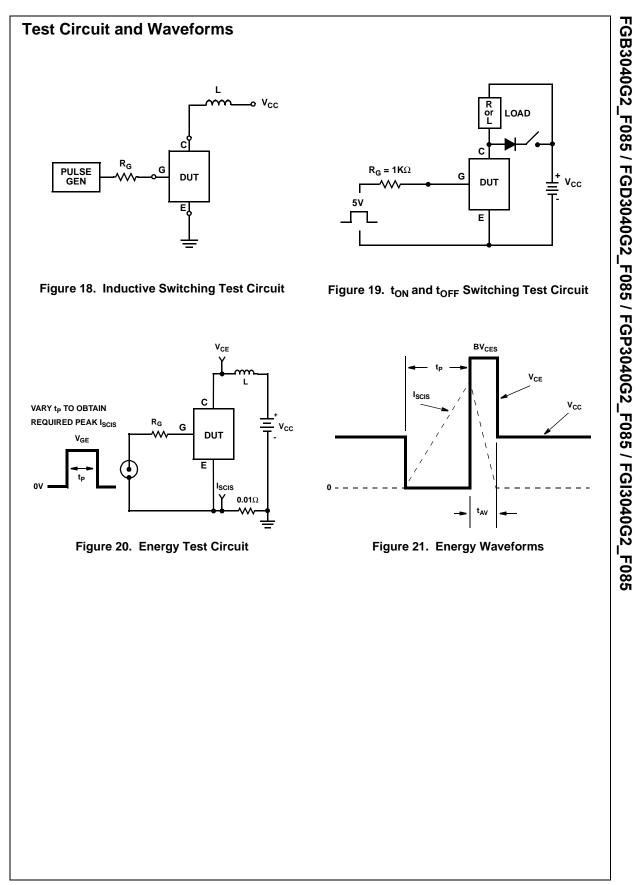


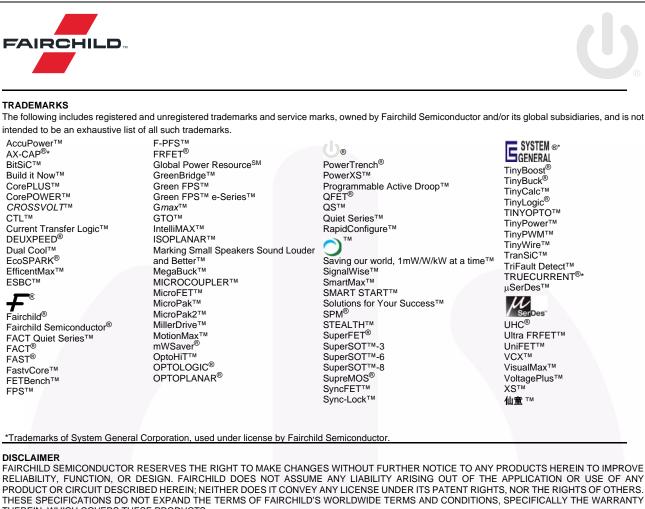
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